

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	207920	(resist or photoresist) with layer	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/02 16:01
S2	111175	(( Sc or V or Mn or Fe or Co or Ni, or Zn or Ga or Ge or As or Se or Br or Kr or Sr or Y or Zr or Nb or Tc or Ru or Rh or Pd or Ag or Cd or Sn or Sb or Te or I or Xe or Ba or La or Hf or Ce or Pr or Nd or Sm or Eu or Gd or Tb or Dy or Ho or Er or Tm or Yb or Lu) with layer) same S1	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/02 16:05
S3	59023	(( Sc or V or Mn or Fe or Co or Ni, or Zn or Ga or Ge or As or Se or Br or Kr or Sr or Y or Zr or Nb or Tc or Ru or Rh or Pd or Ag or Cd or Sn or Sb or Te or I or Xe or Ba or La or Hf or Ce or Pr or Nd or Sm or Eu or Gd or Tb or Dy or Ho or Er or Tm or Yb or Lu) with layer) same S1 same substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/02 16:07
S5	1190	430/270.1 and S3	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/02 16:12

S6	17278	(( "Sc" or "V" or "Mn" or "Fe" or "Co" or "Ni" or "Zn" or "Ga" or "Ge" or "Se" or "Br" or "Kr" or "Sr" or "Y" or "Zr" or "Nb" or "Tc" or "Ru" or "Rh" or "Pd" or "Ag" or "Cd" or "Sn" or "Sb" or "Te" or "I" or "Xe" or "Ba" or "La" or "Hf" or "Ce" or "Pr" or "Nd" or "Sm" or "Eu" or "Gd" or "Tb" or "Dy" or "Ho" or "Er" or "Tm" or "Yb" or "Lu") with layer) same S1 same substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/02 16:17
S7	364	430/270.1 and S6	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/02 16:20
S8	8758	(resist or photoresist) with layer with metal with substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/02 16:35
S9	5193	((resist or photoresist) near layer) same (metal near layer) same substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/02 16:36
S10	122	((resist or photoresist) near layer) same ((Re or Os or Ir or Pt) near layer) same substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/02 16:56
S11	199	((resist or photoresist) near layer) same (metal near layer) same substrate same "electron beam"	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/02 17:17
S12	3	*3853715".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/03 13:45

S13	2	*4454014".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/03 13:46
S14	2	*6236621".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/03 13:48
S15	303	pyroelectric and Pt and (resist or photoresist)	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/03 13:49
S16	208133	(resist or photoresist) with layer	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/03 14:00
S17	59082	(( Sc or V or Mn or Fe or Co or Ni, or Zn or Ga or Ge or As or Se or Br or Kr or Sr or Y or Zr or Nb or Tc or Ru or Rh or Pd or Ag or Cd or Sn or Sb or Te or I or Xe or Ba or La or Hf or Ce or Pr or Nd or Sm or Eu or Gd or Tb or Dy or Ho or Er or Tm or Yb or Lu) with layer) same S16 same substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/03 14:00
S18	1824	430/311 and S17	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/03 14:00
S19	276	resist same (metallic substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/03 14:48
S20	417	"copper alloy" same "percent copper"	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/03 15:11
S21	2	*5521034".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT	ADJ	ON	2008/04/03 15:28

4/ 4/ 2008 7:17:30 AM

C:\Documents and Settings\AEoff\My Documents\EAST\Workspaces\10787407-3.wsp